

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Tatsuya MIYAZAKI	03/18/2011
RECEIVING PARTY DATA	
Name:	Elpida Memory, Inc.
Street Address:	2-1, Yaesu 2-chome, Chuo-ku
City:	Tokyo
State/Country:	JAPAN
Postal Code:	104-0028
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	13069754
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ATTORNEY DOCKET NUMBER:	653412005900
NAME OF SUBMITTER:	Christopher W. Ferguson
Total Attachments: 2 source=653412005900#page1.tif source=653412005900#page2.tif	

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PATENT
REEL: 026068 FRAME: 0153

MORRISON & FOERSTER LLP

For good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, the undersigned hereby assign, transfer and set over to:

Elpida Memory, Inc. of 2-1, Yaesu 2-chome, Chuo-ku, Tokyo, Japan

(hereinafter designated as the "ASSIGNEE"), its successors and assigns, the entire right, title, and interest for the United States in the invention, and all applications for patent and any Letters Patent which may be granted therefore, including said application, and all United States Letters Patent which may be granted thereof, and all divisions, reissues, continuations and extensions thereof, the said interest being the entire ownership of said Letters Patent when granted to be held by said ASSIGNEE, its successors, assigns or their legal representatives, to the full end of the term for which said Letters Patent may be granted, as fully and entirely as the same would have been and enjoyed by Assignors if this assignment had not been made, the application being known by the title:

METHOD OF MANUFACTURING SEMICONDUCTOR DEVICE

Attorney Docket No.: 653412005900

for which the undersigned has/have executed an application for patent in the United States of America on the same day herewith. Where this instrument is not filed concurrently with the application, the following identifying information may be added after execution:

Serial No.: 13/069,754

Filing Date: March 23, 2011

1. The undersigned hereby agree to sign and execute any further documents and instruments which may be necessary, lawful and proper in the prosecution of said above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reexamination or reissue application or in any amendments, extension of interference proceedings, or otherwise to secure the title thereto to the ASSIGNEE.

2. The undersigned agree to execute all papers and documents and perform any act which may be necessary in connection with claims or provisions of the International Convention for Protection of Industrial Property of similar agreements.

3. The undersigned agree to perform all affirmative acts which may be necessary to obtain a grant of a valid United States patent to the ASSIGNEE.

4. The undersigned hereby authorize and request the Commissioner of Patents in the United States to issue any and all Letters Patent

resulting from said application or any division or divisions or continuing applications thereof to the said ASSIGNEE.

5. The undersigned hereby grant to the firm of Morrison & Foerster LLP the power to insert on this assignment any further identification which may be necessary or desirable in order to comply with the rules of the United States Patent and Trademark Office for recordation of this document.

IN WITNESS WHEREBY, executed by the undersigned on the dates opposite the undersigned names.

March 18, 2011

Date

Tatsuya Miyazaki

Typed Name: Tatsuya MIYAZAKI